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5.1 Schematic

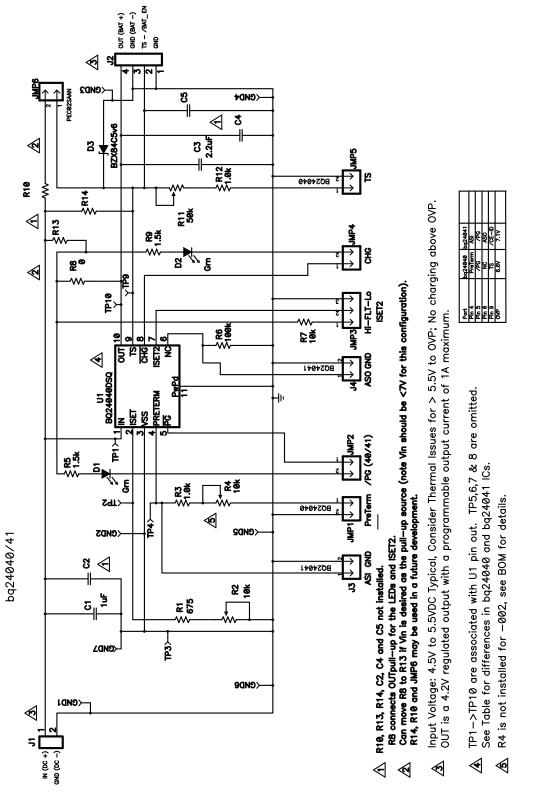


Figure 2. bq24040/41 EVM Board Schematic

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